WIRE WOUND CHIP COMMON MODE COIL 片式共模绕线电感

● FEATURES 特性

1.High common mode impedance at high frequency effects excellent noise suppression performance.
高频共模阻抗高，噪声抑制性能优良.

2.20Ω~2000Ω are optional for different noise level and signal frequency
对于不同的噪声电频和信号频率，选择20Ω~2000Ω阻抗.

● APPLICATIONS 用途

1.USB 2.0 line for personal computers and peripheral
电脑和外围设备的USB 2.0线路.

2.IEEE 1394 line for personal computers, DVC, STB
用于计算机、DVC、机顶盒的IEEE 1394线路.

3.LVDS, panel line for liquid display panels, graph card,etc.
LVDS，用于液体显示面板的面板线，图形卡等.

● PART NUMBERING SYSTEM 品名系统

CMF	3216	D	900	P	T -	HF
A	B	C	D	E	F	G

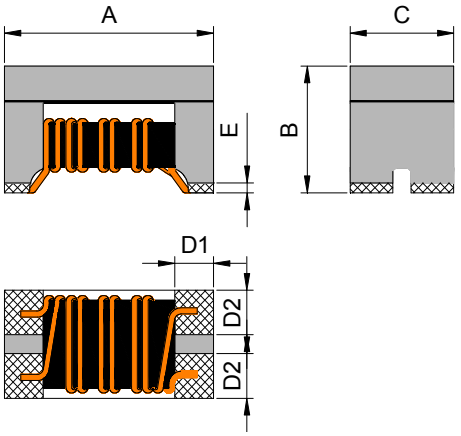
A: Product code　　B:Dimensions :L*H

C: Material type 材料类型　　D: Impedance Value 阻抗值 900 = 90Ω

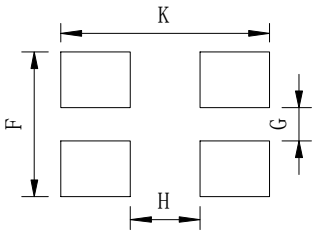
E：Tolerance (P:±25%)　　F:T:Tape and Reel

G:HF—Halogen Free

● SHAPES AND DIMENSIONS 外形尺寸 (Unit:mm)

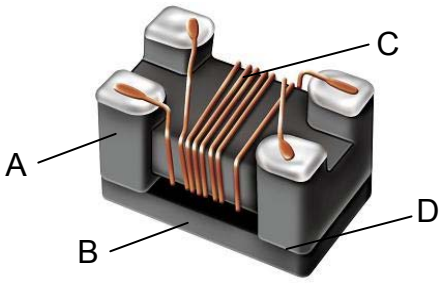


Recommended Land Pattern



TYPE(型号)	A	B	C	D1	D2	E	F	G	H	K
CMF2012	2.0±0.2	1.2±0.2	1.2±0.2	0.5 Ref	0.45 Ref	0.17 Max	1.2 Ref	0.4 Ref	0.8 Ref	2.0 Ref
CMF3216	3.2±0.2	1.8±0.2	1.6±0.2	0.7 Ref	0.6 Ref	0.22 Max	1.6 Ref	0.4 Ref	1.6 Ref	3.0 Ref
CMF4532	4.5±0.2	2.8±0.2	3.2±0.2	0.8 Ref	1.1 Ref	0.5 Max	3.2 Ref	1.0 Ref	2.0 Ref	5.1 Ref

● STRUCTURE AND MATERIAL



Part	Components	Material
A	Core	Ferrite
B	I Core	Ferrite
C	Wire	Polyurethane enameled copper wire
D	Epoxy	Epoxy resin

● ELECTRICAL CHARACTERISTICS

1. Operating temperature range : -40℃～85℃(Including self - temperature rise)

2. Storage temperature range (packaging conditions): -10℃~+40℃ and RH 70% (Max.)

● TEST AND MEASUREMENT PROCEDURES

1. Common Mode Impedance(Ω)

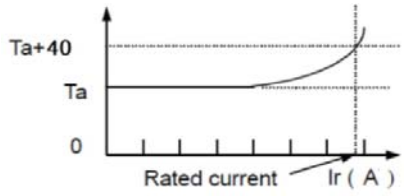
Test equipment: Keysight E4991B / Agilent 4787A or equivalent

2. DC Resistance (DCR)

Test equipment: Agilent34420A / Agilent 4338B or equivalent

3. Rated Current (Irms)

Irms is direct electric current as chip surface temperature rose just 40 against chip initial surface temperature (Ta)



4. Insulation Resistance

Test equipment: Chroma or equivalent TH2683A / ZX6583

● RECOMMENDED SOLDERING TECHNOLOGIES

Re-flowing Profile

Preheat condition: 150~200 /60~120sec.

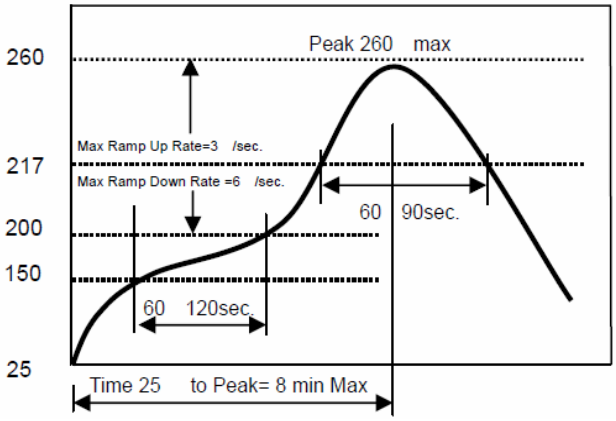
Allowed time above 217C: 60~90sec.

Max temp: 260

Max time at max temp: 10sec

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2 times max



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● SPECIFICATION TABLE:

CMF2012 Series

Part No.	Common Mode Impedance(Ω)	Test Frequency (MHz)	DCR (Ω) Max	Max. Rated Current (mA)	Rated Voltage (Vdc)	Insulation Resistance (MΩ) Min.
CMF2012D300PT-HF	30±25%	100	0.20	450	50	10
CMF2012D670PT-HF	67±25%	100	0.25	400	50	10
CMF2012D750PT-HF	75±25%	100	0.30	400	50	10
CMF2012D900-PT-HF	90±25%	100	0.30	330	50	10
CMF2012D121PT-HF	120±25%	100	0.30	370	50	10
CMF2012D181PT-HF	180±25%	100	0.35	330	50	10
CMF2012D201PT-HF	200±25%	100	0.35	330	50	10
CMF2012D221PT-HF	220±25%	100	0.40	300	50	10
CMF2012D261PT-HF	260±25%	100	0.40	300	50	10
CMF2012D371PT-HF	370±25%	100	0.45	280	50	10
CMF2012D601PT-HF	600±25%	100	0.60	220	50	10
CMF2012D751PT-HF	750±25%	100	0.70	180	50	10
CMF2012D801PT-HF	800±25%	100	0.75	160	50	10
CMF2012D901PT-HF	900±25%	100	0.80	150	50	10
CMF2012D102PT-HF	1000±25%	100	0.80	150	50	10

1. Operating temperature range : -40℃～85℃(Including self - temperature rise)
2. Storage temperature range (packaging conditions): -10℃~+40℃ and RH 70% (Max.)
3. Rated Current (Irms)
   Irms is direct electric current as chip surface temperature rose just 40 against chip initial surface temperature (Ta)

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● SPECIFICATION TABLE:

CMF3216 Series

Part No.	Common Mode Impedance(Ω)	Test Frequency (MHz)	DCR (Ω) Max	Max. Rated Current (mA)	Rated Voltage (Vdc)	Insulation Resistance (MΩ) Min.
CMF3216D900PT-HF	90±25%	100	0.30	370	50	10
CMF3216D161PT-HF	160±25%	100	0.40	340	50	10
CMF3216D261PT-HF	260±25%	100	0.50	310	50	10
CMF3216D601PT-HF	600±25%	100	0.80	260	50	10
CMF3216D102PT-HF	1000±25%	100	1.00	230	50	10
CMF3216D222PT-HF	2200±25%	100	1.20	200	50	10

CMF4532 Series

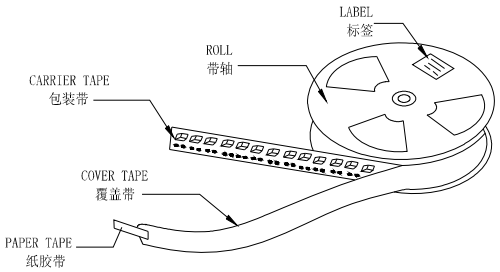
Part No.	Common Mode Impedance(Ω)	Test Frequency (MHz)	DCR (Ω) Max	Max. Rated Current (mA)	Rated Voltage (Vdc)	Insulation Resistance (MΩ) Min.
CMF4532D331PT-HF	330±25%	100	0.11	1100	50	10
CMF4532D601PT-HF	600±25%	100	0.12	1000	50	10
CMF4532D801PT-HF	800±25%	100	0.16	900	50	10

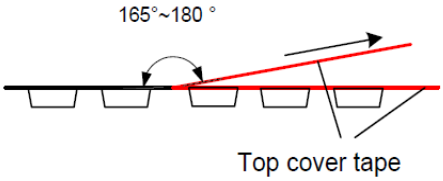
1. Operating temperature range : -40℃～85℃(Including self - temperature rise)
2. Storage temperature range (packaging conditions): -10℃~+40℃ and RH 70% (Max.)
3. Rated Current (Irms)
   Irms is direct electric current as chip surface temperature rose just 40 against chip initial surface temperature (Ta)

● PACKAGING SPECIFICATION :

1. Packaging - Cover Tape

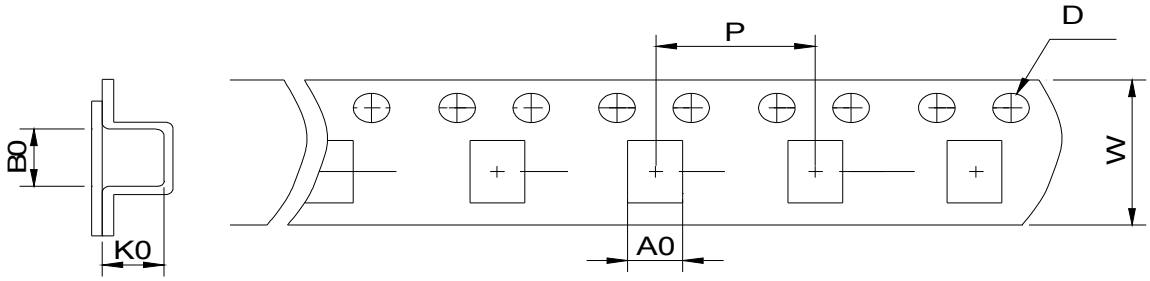
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.

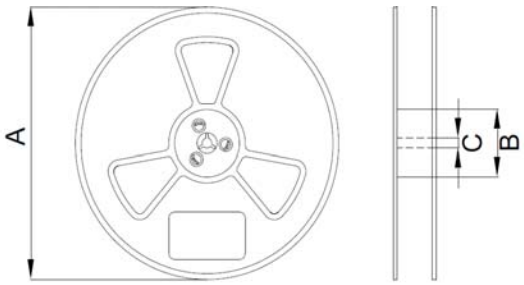




Peel-off speed: 300mm/min.

2. Packaging - Tape & Reel





Type	Tape Dimension (mm)						Reel Dimension (mm)			Quantity (Pcs/Reel)
	W	A0	B0	K0	D	P	A	B	C	
CMC2012	8	1.5	2.3	1.55	1.5	4	178	58	13	2000 pcs
CMC3216	8	2	3.6	2.2	1.5	4	178	58	13	2000 pcs
CMC4532	16	3.6	4.9	3.2	1.5	8	330	100	13	500 pcs